

Application Data Sheet Under 37 § C.F.R. 1.76

1. Inventor Information:

Full Name of First or Sole Inventor	Citizenship
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3. Application Information

Filing status: Small entity  
Title of the Invention: Lead-free solder  
Class: (when available)  
Subclass: (when available)  
Technology Center: (when available)  
Total number of Drawing Sheets: 4  
Docket Number:  
Type of Application: Utility

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5. Domestic Priority Information:

(None)

6. Foreign Priority Information:

(None)

7. Assignment Information:

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